## 10/611,395

L Number	Hits	Search Text	DB	Time stamp
1	2016	((438/455) or (257/777)).CCLS.	USPAT;	2004/07/21 17:22
,			US-PGPUB,	
			EPO; JPO;	
	:		DERWENT;	
			IBM_TDB	
2	1925	(((438/455) or (257/777)).CCLS.) and @ad<20030630	USPAT;	2004/07/21 17:22
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM_TDB	
_	26	(("5102821") or ("5373184") or ("5413952") or ("5849627")	USPAT;	2004/07/21 14:58
	20	or ("5866469") or ("5882532") or ("20020160582") or	US-PGPUB;	2007/07/21 17.36
		("20020076902") or ("20020001920") or ("20020195673")	EPO; JPO;	
		or ("6406636") or ("6380629") or ("20030060020")).PN.	DERWENT;	
		, . , ( , , ,	IBM TDB	
-	0	(wafer adj bond\$3) and @ad<20030630 and ((native adj	USPAT;	2004/07/21 15:00
		oxide) near4 remov\$3) and ((pad terminal electrode) near3	US-PGPUB;	, .
		(cu copper)) and (electroplat\$3 electroless) and (conductive	EPO; JPO;	
1		near3 adhesive)	DERWENT;	
	_		IBM_TDB	
-	0	(wafer adj bond\$3) and @ad<20030630 and ((native adj	USPAT;	2004/07/21 15:00
		oxide) near4 remov\$3) and ((pad terminal electrode) near3	US-PGPUB;	
		(cu copper)) and (electroplat\$3 electroless)	EPO; JPO;	
			DERWENT; IBM_TDB	
_	22	@ad<20030630 and ((native adj oxide) near4 remov\$3) and	USPAT;	2004/07/21 17:22
	22	((pad terminal electrode) near3 (cu copper)) and	US-PGPUB;	2007/07/21 17.22
		(electroplat\$3 electroless)	EPO; JPO;	
		( ) ( ) ( ) ( ) ( ) ( ) ( ) ( ) ( ) ( )	DERWENT;	
			IBM_TDB	